ESCC

APPLICATION FOR EXTENSION OF ESCC QUALIFICATION APPROVAL

Component Title:

DIODES, MICROWAVE, SILICON, SCHOTTKY, GENERAL PURPOSE, BASED ON TYPES BAS40 AND BAS70 , BYY 42, BYY43, BYY44

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Appl. No.

C. Carried St.	E	xecutive Member:	DLR		Date	02/05/2016	227 F	
Components (includi	ng series and families) s	ubmitted for Extension	of Qualification	Approval:				
ESCC COMPONENT VARIANTS RANGE NO.			OF COMPONENTS BASED ON		TEST VEHICLE / S		COMPONENT SIMILAR	
5512/020	01			BAS40	В	AS40-T1(ES)		
	03							
55/3/017	01,02			BYY47	2	_	Y	
5513/030	01,02,05,06			B X Y 43	144	_	Y	
Component Ma Infineon Technologie		Location of Manufacturing Plant(s) Am Campeon 1-12 D- 85579 Neubiberg Germany			Date of original qualification approval: Date: 01/09/1996 Certificate Ref No. 227			
ESCC Specifications		Deviations to LVT te	esting and Detail	6 Specification		tion Extension Report		7
Maintenance of qualit Generic: 5010	fication testing: Issue: 02	used: No ⊠ Yes □ (supply details in Box 15)			reference and date: 1609LR12a Iss 1a, May 2016			
Detail(s); 5512/02	0 Issue: 03	Deviation from curre No ⊠ Yes	ent Specifications (Supply		1			
Summary of procurer	ment or equivalent test re	esults during current v	alidity period in s	upport of this ap	plication (t	hose to ESCC listed fir	rst)	8
Project Name	Testing Level	LAT Date code			Quantity Delivered			
PID changes since st None ⊠	art of qualification	9	Current PID	Verified by:	Name	G. Joormann	ntative	10
Minor*			1905/0200025550F	A63500 - D336	– P000 - *			
Major* □	*Provide details in box:		Issue: Rev Date:	01/10/2015		Date:	26/04/2016	
Current Manufacturin	g facilities surveyed by:	(Name	G. Joorman	12011)) оп		10/2016 Date)	11
Satisfactory: Report Reference:	Yes ⊠ IFX-AUD-2015	No □ Exp	olain					

APPLICATION FOR EXTENSION OF ESCC QUALIFICATION APPROVAL

Component title:

DIODES, MICROWAVE, SILICON, SCHOTTKY, GENERAL PURPOSE, BASED ON TYPES BAS40 AND BAS70 8 XY 42, 8 XY 45, 8 XY 44, DLR Date: 02/05/2016

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	Executive Mem	ber. DLR		Date. 02/03/2010	227 F
The same two testings are the same	SCALAR BEAUTY OF				
ailure Analysis, DPA, NCC	CS available: Ye	s □ No ⊠	(Supply data)		
f. No's and purposes:					
e undersigned hereby certifies or	n behalf of the ESCC Exe	cutive - that the above in	formation is correct; -	0.1.1.0000°	-
t the appropriate documentation cept as stated in box 15;) - that t	has been evaluated; - the	at full compliance to all E available at the ESCC Ex	ecutive and therefore	applies on behalf of	
as the respon	sible Executive Member 1	for ESCC qualification sta	atus to be extended to	the component(s) listed h	nerein.
00/05/0045				i A G I	oormann
e: 02/05/2016				(Signature of the Exe	
				V. 3	,
tinuation of Boxes above:					Ł
ADDITIONAL	IDEFICIT 6	PID. APPLY	2 🛊		
A635	00-D306-	A1-*- 76	cs (B)	(Y42)	
A635	00-T1580Y	3-1000-	-76K5	BXY43,49)
a la					
GENONIC P	500-GEPI	O ALJO:	man resource to the	10 M	A166
A63	SBO-GEPI	D- P000-	K-76K5	110	
		1,60			



APPLICATION FOR EXTENSION OF ESCC QUALIFICATION APPROVAL

Component title:

DIODES, MICROWAVE, SILICON, SCHOTTKY, GENERAL PURPOSE, BASED ON TYPES BAS40, AND BAS70, BXY42, BXY43

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Executive Member:

BXY 44

Date: 02/05/2016

Non comp	bliance to ESCC_requirements:		15
No.:	Specification	Paragraph	Non compliance
1	E1CC 5010	CHART FY	no periodic repetition of Endurance SG.
		e for ESCC qualification or rationale for acceptab	ility of
	*		10
The	approved PIB	nalification, regard	of methodology for ding similarity, in § 7.
ma	incenance of s)/ =
Executive	Manager Disposition		122
	n Approval: Yes 🗹 No		17
Action / R			
CER	TIFICATE 227 is	RE-SCOPED FROM TH	is Extension to
INC	LUDE DEVICES/VAR	IANTS PREVIOUSLY QU	VALIFIED UNDER
CEV	ETIFICATES ZZY, 7	277 AND 236 (224	AND 236 ARE
-	0 = CD0 = NO / AA	GER UP-ISSUED).	
IHE	WEFFORE NO LON	0-612 07-1350001.	
Date:			

ESCC

APPLICATION FOR EXTENSION OF ESCC QUALIFICATION APPROVAL

Component Title:

DIODES, MICROWAVE, SILICON, SCHOTTKY, GENERAL PURPOSE, BASED ON TYPES BAS40 AND BAS70 18 XY41, 6 XY413, BY444

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Executive Member:

DIR

Date: 02/05/2016

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ANNEX 1: LIST OF TESTS DONE TO SUPPORT EXTENSION OF QUALIFICATION

Tests conducted in compliance with:

ESCC 5010 generic specification; Chart V (for ESCC/QPL parts);
 Or PID-TFD BAS40&BAS70(ES) (for ESCC/QML parts)

Tests vehicle identification/description:

BAS40-T1(ES)		

Detail Specification reference:

5512 020 / 03

Chart V	Test	Tick when done	Conditions	Date Code Diffusion Lot	Tested Qty	No. of Rejects	Comments if not performed. Comments on Rejection
	Thermal Shock Test	\boxtimes	ESCC 5010 Para. 9.5.2	1505A	8	0	
so.	Shock Test		MIL-STD-750 Test Method 2016			70.37	n.a. acc. Detail Spec
group	Vibration Test		MIL-STD-750 Test Method 2056			\ \	n.a. acc. Detail Spec
al Sub	Constant Acceleration		MIL-STD-750 Test Method 2006				n.a. acc. Detail Spec
Environmental/Mechanical Subgroups	Seal Test		MIL-STD-750 Test Method 1071				n.a. acc. Detail Spec
al/Mec	Moisture Resistance	⋈	MIL-STD-750 Test Method 1021	1505A	8	0	
nment	Seal Test	⊠	MIL-STD-750 Test Method 1071	1505A	8	0	
Enviror	Electrical Measurements at Room Temp.	⊠	Table 2 of the Detail Specification	1505A	8	0	
	External Visual Inspection	×	ESCC Basic Specification No. 20500	1505A	8	0	
	Operating Life		MIL-STD-750 Test Method 1026				Former data from Wafer available
Subgroup	Electrical Measurements during Endur. Test		Table 6 of the Detail Specification				Former data from Wafer available
☆	External Visual Inspection		ESCC Basic Specification No. 20500	34.7-			Former data from Wafer available

LATZ ON ACTUAL WAFER WAS PERFORMED SATISFACTORILY ON DC. 9444A.



APPLICATION FOR EXTENSION OF ESCC QUALIFICATION APPROVAL

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Chart V	Test	Tick when done	Conditions	Date Code Diffusion Lot	Tested Qty	No. of Rejects	Comments if not performed. Comments on Rejection
Electrical Subgroup – Electrical Measurements	Electrical Measurements at Room Temp.	×	Table 2 of the Detail Specification	1505A	2	0	
	Electrical Measurements at High & Low Temp's	×	Table 3 of the Detail Specification	1505A	2	0	
Electrical ectrical N	External Visual Inspection	×	ESCC Basic Specification No. 20500	1505A	2	0	
E E	Special Testing		The Detail Specification				n.a. acc. Detail Spec
Electrical Subgroup - Assembly Capability Tests	Solderability Test	×	MIL-STD-750 Test Method 2026	1505A	2	0	
	Permanence of Marking	×	ESCC Basic Specification No. 24800	1505A	2	0	
	Terminal Strength	⊠	MIL-STD-750 Test Method 2036	1505A	2	0	
De- encapsulation Tests	Internal visual inspection	Ø	ESCC Basic Specification No. 20400	1505A	8	0	
	Bond Strength	⊠	MIL-STD-750 Test Method 2037	1505A	8	0	
	Die Shear	×	MIL-STD-750 Test Method 2017	1505A	8	0	em lime



Box 22

Additional Comments.

APPLICATION FOR EXTENSION OF ESCC QUALIFICATION APPROVAL

Component title:

DIODES, MICROWAVE, SILICON, SCHOTTKY, GENERAL PURPOSE, BASED ON TYPES BAS40 AND BAS70 , BYY 4 2 DLR GXY43, BXY44

Date: 02/05/2016 Executive Member:

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NOTES ON THE COMPLETION OF THE APPLICATION FORM FOR ESCC QUALIFICATION EXTENSION APPROVAL

	NOTES ON THE COMPLETION OF THE APPLICATION FORM FOR ESCC QUALIFICATION EXTENSION APPROVAL
ENTRIES	
Form heading	shall indicate: - the title of the component as given in its detail specification or the name of the series, family; - the Executive Member; - the entering date; - the certificate number and its sequential suffix.
Box 1	shall provide details given in the table; in particular there shall be listed: - the variants or range of variants; - the range of components (the ESCC code is recommended to indicate the values or values range, the tolerance, the voltage, etc); the designation given in the detail specification as 'base on'; - under Test Vehicle enter either an ESCC code or the specific characteristic capable of identifying the component tested (e.g., voltage of coil for a relay); - under component similar enter a cross if relevant.
Box 2; 3 and 4	As per QPL entry; otherwise, an explanation of the changes must be supplied.
Box 5	Will show the ESCC Generic and Detail specifications, including issue number and revision letter, current at the time the tests reported were performed. If the specifications are different from those current on the date of the application, see Box 6.
Box 6	Will show the deviations from the Generic and Detail Specifications listed in Box 5, in particular deviations from testing. In case of deviations this must be listed in Box 15. In case the referenced specification in Box 5 have currently a different issue and/or revision indicate also whether the test data deviates or not from such current documents.
Box 7	Must reference the report(s) supplied in support of the application.
Box 8	Should provide the details of procurement to the full ESCC System, documentation of all of which should already have been delivered to the ESCC Executive under the terms of the relevant Generic Specification. An appropriate table has been drawn in this box.
Box 9	If the PID evolved after the Original Qualification or after the last Extension of Qualification, adequate details of such evolution shall be provided together with the reasons for the changes. Major changes shall be clearly marked.
Box 10	Identify the current PID issue status, date and actual date of verification. The date of verification of the current PID should be arranged as close as possible to the required date of extension.
Box 11	This box can be completed only after a physical visit to the plant to confirm that no unexplained changes occurred and that the practices, procedures, material, etc. used in manufacturing the components are as described in the PID. This survey shall be carried out in accordance with the requirements of ESCC Basic Specification No. 20200 and its findings shall be recorded.
Box 12	Provide details of, or reference to, any Destructive Physical Analysis (DPA) and Failure Analysis reports as well as any Nonconformance(s) (NCCS) occurred during the qualification validity period, stating if established corrective action have produced satisfactory results.
Box 13	Enter only the name of the Executive Member (i.e., CNES, DLR, ESTEC, etc.) and the signature of the responsible Executive Coordinator.
Box 14	To be used when there is a need to expand any of the boxes from 1 through 12. Identify box affected and reference the Box 14 in the relevant Box. Box 14 can be broken into 14a, 14b, etc. if several boxes have to be expanded.
Box 15	Fill in Table as requested.
Box 16	Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the noncompliance.
Box 17	All Executive Manager recommendations on the application itself, special conditions or restrictions, modifications of the QPL or QML entry, letters to the manufacturer, etc. shall be entered clearly in Box 19, signed by the representative for ESA, and dated.
Box 18	Fill in Table as requested.
Box 19	Confidential Details of PID changes including those of a confidential nature, shall be provided.
Box 20	State noncompliance with reference to specification(s) and paragraph(s). To simplify reference in Box 16 each nonconformance shall be sequentially numbered. If relevant state 'None'.
Box 21	Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the noncompliance.